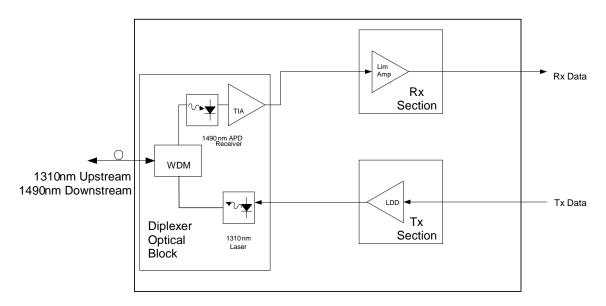






Features

- Single Fiber, CWDM Integrated Diplexer Transceiver
- 2x5 SFF pinout
- 2x10 SFF pinout supports I2C digital diagnostics
- Voice/Data FTTx ONT/ONU Applications
- 1244 Mbps Tx, 2488 Mbps Rx Asymmetric Data Rate
- 5 Wavelength Pairs Available
- Burst Mode Transmission
- TX Burst Mode Detection, TX-SD
- Commercial temperature
- 28 dB link budget; 20 km reach
- Compliant to IEC-60825 Class 1 laser diode
- SC/APC or SC/UPC fiber connector
- · RoHS compliant
- **Digital Transmitter:** A CWDM laser diode is employed for upstream transmission at OC-24 (1244Mbps). The optical transmitter includes a back facet photodetector to monitor laser power for APC control.
- Digital Receiver: An APD with TIA is employed for downstream data reception at OC-48 (2488Mbps). A post amplifier is also included for CML output compatibility.



Diplexer Block Diagram



Absolute Maximum Ratings

Usage of this transceiver shall adhere to the following absolute maximum ratings. Stresses beyond those in Table 1 may cause permanent damage to the unit. These are stress ratings only, and functional operation of the unit at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect unit reliability.

Table 1 - Absolute Maximum Ratings						
Parameter	Minimum	Maximum	Unit/Conditions			
Ambient Storage Temperature	-40	85	°C			
Operating Temperature*	0	70	°C, C-Temp			
Operating Humidity Range	10%	90%	non-condensing			
ESD Sensitivity (Human Body Model)	-	1000	V			
Lead Soldering Temperature	-	260°C	10 sec			
Vcc_Rx	-0.4	+4.2	V			
Vcc_Tx	-0.4	Vcc_Rx + 1	V			

^{*}Operating temperature minimum is ambient, maximum is module case temperature.

Module Characteristics

Table 2 - Module Characteristics							
Parameter	Minimum	Typical	Maximum	Unit/Conditions			
Tx to Rx Crosstalk	-	-	-47	dB			
Total TX and RX Supply Current	-	-	350	mA			



Functional Characteristics

The following tables list the performance specifications for the various functional blocks of the integrated optical transceiver module.

Parameter	Minimum	Typical	Maximum	Unit	Notes
Operating Voltage	3.14	3.30	3.46	V	V _{CC} referenced to GND_Tx
Data Rate	-	1244.16	-	Mbps	
Average Optical Output Power, P ₀ (BOL)	1.5	-	5	dBm	
Average Optical Output Power, P ₀ (BOL)	0.5	-	5	dBm	
Output Power at Transmit Off	-	-	-40	dBm	
Extinction Ratio	10	-	-	dB	PRBS 2 ²³ -1, NRZ, 50% duty cycle
Transmitter Output Eye	G	.984.2 Figure	3		
Optical Rise and Fall Time	-	250	-	ps	20% to 80%
		1271			
		1291			
Center Wavelength		1311		nm	C-temp ±6.5nm
		1331			
		1351			
SMSR		30		dB	
Differential Input Voltage, V _{in}	200	-	1600	mVp-p	TXD+/ DC-coupled
Common Mode Input Voltage	GND_Tx +		Vcc - (V _{in} /2) -	V	DC coupled
Common-Mode Input Voltage	1.4	-	0.1	V	DC coupled
Tx Burst Enable Time	-	-	12.86	ns	16 bits data @ 1244Mbps
Tx Burst Disable Time	-	-	12.86	ns	16 bits data @ 1244Mbps
Jitter Generation	-	-	0.2	UI	4 kHz to 10 MHz
TX_DIS Input Low	0		0.8	V	
TX_DIS Input High	2.0		Vcc_RX	V	
TX_SD timing "D"			1000	ns	See figure 3
TX_SD timing "X"			350	ns	See figure 3



Refer to Figure 1 which schematically describes the high speed data inputs/outputs of the optical transceiver module.

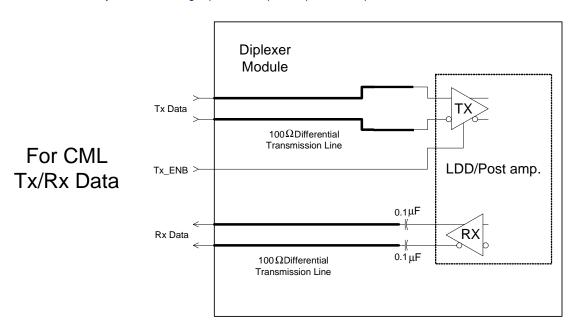


Figure 1 - Schematic representation of the module high speed inputs/outputs

Table 4 – Digital Receiver Specifications					
Parameter	Minimum	Typical	Maximum	Unit	Notes
Operating Voltage	3.14	3.30	3.46	V	V _{CC} referenced to GND_RX
Data Rate	-	2488.32	-	Mbps	
		1451			
		1471			
Operational Wavelength Range		1491		nm	
		1511			
		1531			
Received Optical Power, BOL	-28.0	-	-8	dBm	PRBS 2 ²³ -1, 50% duty cycle
Received Optical Power, EOL	-27.0	-	-8	dBm	PRBS 2 ²³ -1, 50% duty cycle
Data Output Rise and Fall Time	-	160	-	ps	20% to 80%
Signal Detect Assertion Level	-	-	-31	dBm	Transition during increasing light
Signal Detect De-Assertion Level	-45	-	-	dBm	Transition during decreasing light
Signal Detect Hysteresis	0.5	-	6	dB	
Differential Output Voltage	300	-	1200	mV	CML output, ac coupled (0.1μF)
					LVTTL with internal 4.7kΩ pull up
Signal Detect Output HIGH Voltage	2.4	-	-	V	resistor. Asserts HIGH when input
					data amplitude is above threshold.
Signal Datest Output LOW Voltage			0.6	V	LVTTL. De-asserts LOW when input
Signal Detect Output LOW Voltage	-	-	0.6	V	data amplitude is below threshold.
RSSI Range	-28	-	-8	dBm	2x10 only
RSSI Accuracy	-3	-	+3	dB	2x10 only



Table 5 - Microcontroller Specifications						
Parameter	Minimum	Typical	Maximum	Unit	Notes	
Operating Voltage	3.14	3.30	3.46	V		
SDA ^a	-	-	-	-	LVTTL, open collector serial data line from the I ² C bus to the on board Microcontroller. 100kbps max. data rate.	
SCL⁵	-	-	-	-	LVTTL, open collector serial clock line from the I ^c C bus to the on board Microcontroller.	
Reset hold ^c	30	-	-	ms	LVTTL input, internal 50kΩ pull-up. Active Low	

 $^{^{\}rm a}\,$ I $^{\rm 2}{\rm C}$ SDA and SCL must be open collector or open drain connections.

Table 6 – Sugg	Table 6 – Suggested Start-up Sequence					
Step	Action					
1	Power up the host system, with the RESET pin pulled to ground via a \leq 4.7k Ω resistor.					
2	Drive the RESET pin LOW.					
3	Ensure power to the unit is on.					
4	Drive the RESET pin HIGH to release the unit to become operational.					
5	Read byte A2.6E several times. There will be a NACK until the processor is booted, followed by a 01 (DATA READY BAR) until the A2D data is ready, followed by 00 (assuming TXDIS and TXFAIL are inactive).					
6	The unit is now ready for normal operation.					

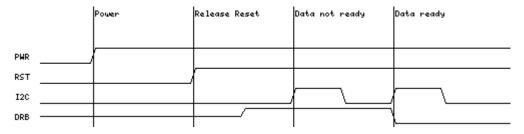


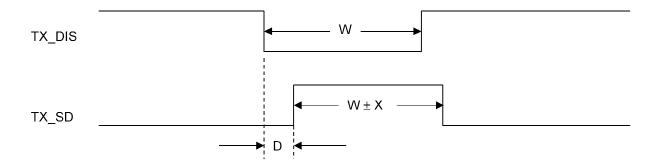
Figure 2 - Recommended transceiver module start-up sequence

^b Clock stretching, as per paragraph 13.2 of the I²C Bus Standard, must be implemented to operate correctly.

^c Please see Table 6 and the timing diagram in Figure 2 below for the recommended system start-up sequence.



Fig 3 TX_SD Timing Diagram



2x5 Pin Definitions

Refer to Table 7 for a description of the function of each I/O pin.

Pin Number	Label	Definition
1	GND_RX	Digital Rx Ground
2	Vcc_RX	Digital Rx Vcc
3	SD	Signal Detect output, pull up internally. Asserts high when input optical power level is above threshold
4	RxD-	RX data bar output, CML. 50Ω terminated to Vcc and AC coupled to module output (0.1μF)
5	RxD+	RX data output, CML. 50Ω terminated to Vcc and AC coupled to module output (0.1μF)
6	Vcc_TX	Digital Tx Vcc
7	GND_TX	Digital Tx Ground
8	TX_DIS	Tx Disable, LVTTL Input (1=TX OFF, 0=TX ON)
9	TxD+	Tx data input, CML. Internally DC coupled. 100Ω differential termination.
10	TxD-	Tx data bar input, CML. Internally DC coupled. 100Ω differential termination.



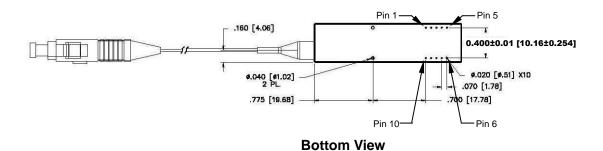
2x10 Pin Definitions

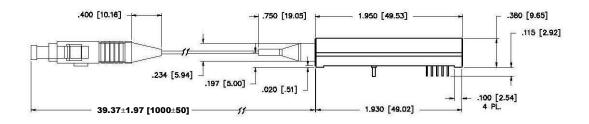
Refer to Table 8 for a description of the function of each I/O pin.

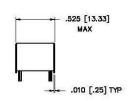
Table 8 - Modu	ule Pin Definitions	
Pin Number	Label	Definition
1	NC	No User Connection
2	GND_RX	Digital Rx ground
3	GND_RX	Digital Rx ground
4	NC	Reserved, No User Connection
5	NC	Reserved, No User Connection
6	GND_RX	Digital Rx Ground
7	Vcc_RX	Digital Rx Vcc
8	SD	Signal Detect output, pull up internally (4.7k Ω). Asserts high when input optical power level is above threshold
9	RxD-	RX data bar output, CML. 50Ω terminated to Vcc and AC coupled to module output (0.1μF)
10	RxD+	RX data output, CML. 50Ω terminated to Vcc and AC coupled to module output (0.1μF)
11	Vcc_TX	Digital Tx Vcc
12	GND_TX	Digital Tx Ground
13	TX_DIS	Tx Disable, LVTTL Input (1=TX OFF, 0=TX ON), internal 47kΩ pull-up.
14	TxD+	Tx data input, CML. Internally DC coupled. 100Ω differential termination.
15	TxD-	Tx data bar input, CML. Internally DC coupled. 100Ω differential termination.
16	GND_TX	Digital Tx Ground
17	SCL	I2C Clock input
18	SDA	I2C Data input/output
19	TX_Fault	TX Fault Alarm, LVTTL, TX Fault state=High, TX Normal state=Low.
20	TX_SD	TX Signal Detect, TX Active state=High. See TX_SD diagram.



SFF 2x5 Package Diagram

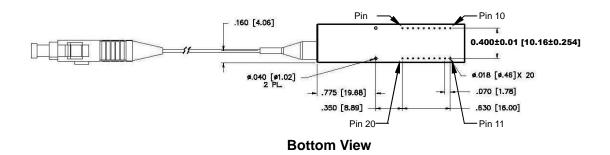


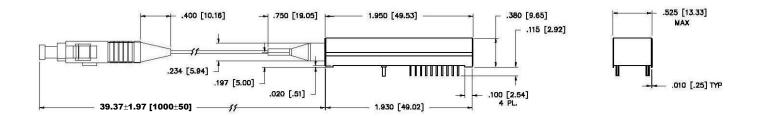






SFF 2x10 Package Diagram







Ordering Information

Table	Table 9 - Ordering Information									
	Connector		TX & RX Wavelength (nm)		Temperature Range	Digital Diagnostic	Design Revision	Customer Specific		
SF	х	ı	xx	-24T-HP-	С	x	E	-xx		
	A = APC		AJ = 1271 & 1451		C = Commercial Temp (0 to 70℃)	N = Non-Diagnostic				
	U = UPC		BK = 1291 & 1471			D = Diagnostic				
			CL = 1311 & 1491							
			DM = 1331 & 1511							
			EN = 1351 & 1531							

Example: SFA-CL-24T-HP-CDE = Transceiver with APC connector, TX=1311nm, RX=1491nm, Commercial Temp, Diagnostic.

Table	e 10 - Device Handling/ESD Protection						
The	The devices are static sensitive and may easily be damaged if care is not taken during handling. The following handling practices are						
reco	mmended.						
1	Devices should be handled on benches with conductive and grounding surfaces.						
2	All personnel, test equipment and tools shall be grounded.						
3	Do not handle the devices by their leads.						
4	Store devices in protective foam or carriers.						
5	Avoid the use of non-conductive plastics, rubber, or silk in the area where the devices are handled						
6	All modules shall be packaged in materials that are anti-static to protect against adverse electrical environments.						
	Avoid applications of any voltage higher than maximum rated voltages to this part. For proper operation, any VIN or VOUT should be						
7	constrained to the range GND ≤ (VIN or VOUT) ≤ VCC. Unused inputs must always be tied to an appropriate logic voltage (e.g.						
	either GND or VCC). Unused outputs must be left open.						



Warnings

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

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